Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L6	10	L5 AND L4	US-PGPUB; USPAT	OR	OFF	2005/10/25 15:36
L5	6462	((438/745,746,753,754,756,757) or (216/83,87,94,96,99,100-108)). CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/25 15:35
L4	145	L3 AND ((liquid\$4 OR wet\$4 OR acid\$4) NEAR20 etch\$4 NEAR20 (infra\$1red\$4 OR radiat\$4))	US-PGPUB; USPAT	OR	OFF	2005/10/25 15:35
L3	3833	L1 AND ((liquid\$4 OR wet\$4 OR acid\$4) NEAR20 etch\$4) AND ((infra\$1red\$4 OR radiat\$4) NEAR20 heat\$4)	US-PGPUB; USPAT	OR	OFF	2005/10/25 15:35
L2	0	L1 AND ((liquid\$4 OR wet\$4 OR acid\$4) NEAR20 etch\$4) AND ((infra\$1red\$4 OR radiat\$4) NEAR20 heat\$4)	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/25 15:35
S79	3833	S75 AND ((liquid\$4 OR wet\$4 OR acid\$4) NEAR20 etch\$4) AND ((infra\$1red\$4 OR radiat\$4) NEAR20 heat\$4)	US-PGPUB; USPAT	OR	OFF	2005/10/25 15:34
L1	168990	(wafer\$4 OR substrate\$4) NEAR20 (clean\$4 OR etch\$)	US-PGPUB; USPAT	OR	OFF	2005/10/25 15:34
S84	6462	((438/745,746,753,754,756,757) or (216/83,87,94,96,99,100-108)). CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/25 13:41
S12	66	(liquid\$4 ADJ etch\$4) AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/25 11:38
S81	14	S80 AND ((liquid\$4 OR wet\$4 OR acid\$4) NEAR20 (infra\$1red\$4 OR radiat\$4) NEAR20 absorb\$4)	US-PGPUB; USPAT	OR	OFF	2005/10/25 09:49
S80	145	S79 AND ((liquid\$4 OR wet\$4 OR acid\$4) NEAR20 etch\$4 NEAR20 (infra\$1red\$4 OR radiat\$4))	US-PGPUB; USPAT	OR	OFF	2005/10/25 09:47
S16	1246	((liquid\$4 OR wet\$4) WITH etch\$4) AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/25 08:59
S75	168990	(wafer\$4 OR substrate\$4) NEAR20 (clean\$4 OR etch\$)	US-PGPUB; USPAT	OR	OFF	2005/10/25 08:58

S50	31536	(semi\$1conduct\$4 WITH wafer\$4) WITH (clean\$4 OR etch\$)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/25 08:57
S74	0	S73 AND ((liquid\$4 OR fluid\$4) WITH (tank\$4 OR bath\$4 OR chamber\$4) WITH quartz\$4 WITH polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 15:02
S73	_ 24508	S72 AND (wet\$4 WITH (clean\$4 OR etch\$))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 15:02
S72	146525	(semi\$1conduct\$4) WITH (clean\$4 OR etch\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 15:02
S66	45	S56 AND ((liquid\$4 OR fluid\$4) WITH (tank\$4 OR bath\$4 OR chamber\$4) WITH quartz\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 15:02
S71	19	S56 AND (infra\$1red\$4 WITH heat\$4 WITH (liquid\$4 OR fluid\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 12:28
S67	7	S66 AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2005/04/25 12:26
S70	1	("6399517").URPN.	USPAT	OR	OFF	2005/04/25 12:14
S69	2	("6022052").URPN.	USPAT	OR	OFF	2005/04/25 12:07
S68	42	S66 AND heat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 11:45

S58	92	S57 AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 11:43
S57	1870	S56 AND ((liquid\$4 OR fluid\$4) WITH (tank\$4 OR bath\$4 OR chamber\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 11:39
S65	3	(("4,960,141") or ("4,643,774") or ("4,714,086")).PN.	USPAT; USOCR	OR	OFF	2005/04/25 11:16
S64	1	("5176756").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/25 11:16
S63	102	S61 AND ((liquid\$4 OR fluid\$4) WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:46
S62	76	S61 AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:45
S61	171	S60 AND (infra\$1red\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:36
S60	926	S57 AND (temperature\$4 WITH (control\$4 OR maintain\$4 OR adjust\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:34
S54	44	S53 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:33

S59		S58 AND (polymer\$4 OR fluoro\$1polymer\$4 OR fluoro\$1carbon\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:31
S53	58	S52 AND (polymer\$4 OR fluoro\$1polymer\$4 OR fluoro\$1carbon\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:30
S52	143	S51 AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:30
S56	24508	S55 AND (wet\$4 WITH (clean\$4 OR etch\$))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:28
S51	5236	S50 AND (wet\$4 WITH (clean\$4 OR etch\$))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:28
S55	146525	(semi\$1conduct\$4) WITH (clean\$4 OR etch\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:27
S31	52	S30 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:17
S43	0	S42 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:15

S28	232	(etch\$4 WITH bath\$4) AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 10:11
S49	3	("6192902").URPN.	USPAT	OR	OFF	2005/04/25 10:09
S48	· 3	("6192902").URPN.	USPAT	OR	OFF	2005/04/25 10:02
S46	160	semi\$1condut\$4 AND (clean\$4 OR etch\$4) WITH (liquid\$4 OR fluid\$4 OR solution\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:56
S45	51	semi\$1condut\$4 AND (clean\$4 OR etch\$4) WITH (liquid\$4 OR fluid\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:56
S47	3	S46 AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:55
S44		semi\$1condut\$4 WITH (clean\$4 OR etch\$4) WITH (liquid\$4 OR fluid\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:54
S42	13	("5567244").URPN.	USPAT	OR	OFF	2005/04/25 09:49
S23	491	S21 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:49
S41	124	S40 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:45
S40	191	S39 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:44

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S29	111	S28 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:44
S39	583	((etch\$4 OR clean\$4) WITH bath\$4) AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:43
S38-	29	S37 AND infra\$1red\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:42
S37	190	S36 AND ((wet\$4 OR liquid\$4) WITH etch\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:41
S36	190	S35 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:40
S35	293	S34 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:37
S20	206	S18 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:37
S15	30	S14 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:37

S34	768	S33 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:36
S14	41	S12 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:36
S33	1092	((liquid\$4 OR wet\$4) WITH etch\$4 WITH chamber\$4) AND heat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2005/04/25 09:35
S32	41	((liquid\$4 OR wet\$4) WITH etch\$4 WITH chamber\$4) AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:35
S30	81	S29 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:28
S19	463	S17 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:28
S18	478	S17 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 09:28
S27	46	("5232511").URPN.	USPAT	OR	OFF	2005/04/25 09:10
S26	13	("5762755").URPN.	USPAT	OR	OFF	2005/04/25 08:48
S25	23	S24 AND (fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:45

S24	206	S23 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:44
S22	31	S21 AND (fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:44
S21	1048	((fluid\$4 OR liquid\$4 OR wet\$4) WITH etch\$4) AND (infra\$1red\$4 WITH heat\$4) AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:42
S9	92	S7 AND (temperature\$4 WITH (control\$4 OR maintain\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:23
S17	1003	S16 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:22
S13	41	S12 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:22
S7	193	S5 AND (polymer\$4 OR fluoro\$1polymer\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 08:21
S4	511	(liquid\$4 WITH etch\$4) AND (infra\$1red\$4 WITH heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ÖR	OFF	2005/04/25 08:18

S11	1	S10 AND (etch\$4 WITH (analyz\$4 OR analys\$4) WITH chemical\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/23 18:31
S10	38	S9 AND (semi\$1conduct\$4 WITH etch\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/23 18:30
<b>S8</b>	190	S7 AND temperature\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/23 18:27
S6	187	S5 AND polymer\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/23 18:26
S5	354	S4 AND semi\$1conduct\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/23 18:25
S2	26	(("4,839,005") or ("5,196,353") or ("5,621,847") or ("5,658,183") or ("5,762,537") or ("5,807,165") or ("5,842,909") or ("5,893,754") or ("5,957,750") or ("5,980,363") or ("5,981,396") or ("6,066,030") or ("6,117,781") or ("6,143,155") or ("6,176,992") or ("6,187,681") or ("6,218,309") or ("6,287,974") or ("6,312,558") or ("6,368,190") or ("6,375,548") or ("6,451,714") or ("6,455,370") or ("20020160606") or ("20030060030") or ("20030057106")) PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/23 18:23
S3	13	(("3,909,598") or ("4,438,500") or ("4,565,669") or ("4,566,312") or ("4,566,804") or ("4,651,285") or ("4,736,083") or ("4,877,624") or ("5,215,715") or ("5,647,976") or ("5,796,080") or ("5,948,307") or ("6,346,418")).PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/23 17:15

S1	23	(("4,839,005") or ("5,196,353") or ("5,621,847") or ("5,658,183") or ("5,762,537") or ("5,807,165") or ("5,842,909") or ("5,893,754") or ("5,957,750") or ("5,980,363") or ("5,981,396") or ("6,066,030") or ("6,117,781") or ("6,143,155") or ("6,176,992") or ("6,187,681") or ("6,218,309") or ("6,287,974") or ("6,312,558") or ("6,368,190") or ("6,375,548") or ("6,451,714") or ("6,455,370")).PN. or ((2002/0160606) or (2003/0060030) or (2003/0057106)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/04/23 16:55
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